



RE933-01

- Epoxy fibre-glass FR4 1.50 mm
 - Double-sided 35 µm Cu
 - Plated through holes (PTH)
 - Surface chem. Ni/Au with solder stop mask
 - Adaption circuit board for TSSOP 8
 - Pitch: 0.65 mm (173 mil)
 - Hole diameter 1.00 mm
 - Size 8.89 x 23.50 mm
- Module-No. Pitch mil Pin Size (mm)

RE933-01 0.650 mm 22.5 8 4.400 (173 mil)

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